

SNUBBERLESS TRIAC

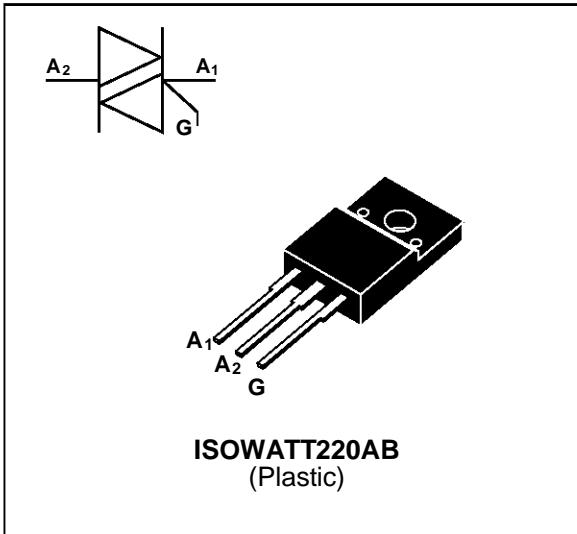
FEATURES

- $I_{TRMS} = 8 \text{ A}$
- $V_{DRM} = V_{RRM} = 400\text{V to } 700\text{V}$
- EXCELLENT SWITCHING PERFORMANCES
- INSULATING VOLTAGE = $1500\text{V}_{(\text{RMS})}$
- U.L. RECOGNIZED : E81734

DESCRIPTION

The T820/830W triacs use high performance glass passivated chip technology, housed in a fully molded plastic ISOWATT220AB package.

The SNUBBERLESS™ concept offers suppression of R-C network, and is suitable for applications such as phase control and static switch on inductive and resistive loads.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(\text{RMS})}$	RMS on-state current (360° conduction angle)	95°C	8 A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$tp = 16.7 \text{ ms}$ (1 cycle, 60 Hz)	88 A
		$tp = 10 \text{ ms}$ (1/2 cycle, 50 Hz)	100
I^2t	I^2t Value (half-cycle, 50 Hz)	10 ms	A^2s
dl/dt	Critical rate of rise of on-state current Gate supply : $I_G = 500 \text{ mA}$ $dl_G/dt = 1 \text{ A}/\mu\text{s}$.	Repetitive $F = 50 \text{ Hz}$	$\text{A}/\mu\text{s}$
		Non Repetitive	20 100
T_{stg} T_j	Storage temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 125	°C
T_I	Maximum lead temperature for soldering during 10s at 4.5 mm from case	260	°C

Symbol	Parameter	T820 / 830-xxxW			Unit
		400	600	700	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 125^\circ\text{C}$	400	600	700	V

T820W / 830W

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	50	°C/W
R _{th(j-c)}	Junction to case for A.C (360° conduction angle)	3.1	°C/W

GATE CHARACTERISTICS (maximum values)

P_{G (AV)}= 1 W P_{GM} = 10 W (tp = 20 µs) I_{GM} = 4 A (tp = 20 µs)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		T820	T830	Unit	
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j = 25°C	I-II-III	MAX	20	30	mA
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j = 25°C	I-II-III	MAX	1.5		V
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j = 125°C	I-II-III	MIN	0.2		V
t _{gt}	V _D =V _{DRM} I _G = 500mA dI _G /dt= 3A/µs	T _j = 25°C	I-II-III	TYP	2		µs
I _H *	I _T = 100mA Gate open	T _j = 25°C		MAX	35	50	
V _{TM} *	I _{TM} = 11A tp= 380µs	T _j = 25°C		MAX	1.5		V
I _{DRM} I _{RRM}	V _{DRM} rated V _{RRM} rated	T _j = 25°C		MAX	10		µA
		T _j = 125°C		MAX	2		mA
dV/dt *	Linear slope up to V _D =67%V _{DRM} Gate open	T _j = 125°C		MIN	200	300	V/µs
(dV/dt)c *	(dI/dt)c = 4.5 A/ms (see note)	T _j = 125°C		MIN	10	20	V/µs

* For either polarity of electrode A2 voltage with reference to electrode A1.

Note : In usual applications where (dI/dt)c is below 4.5 A/ms, the (dV/dt)c is always lower than 10V/µs, and, therefore, it is **unnecessary** to use a snubber R-C network accross T820W / T830W triacs.

Fig.1 : Maximum power dissipation versus RMS on-state current.

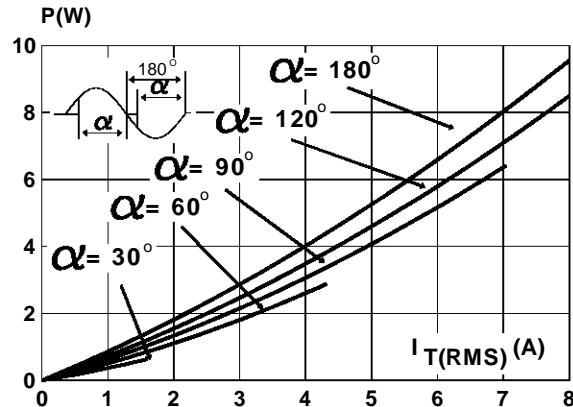


Fig.3 : RMS on-state current versus case temperature.

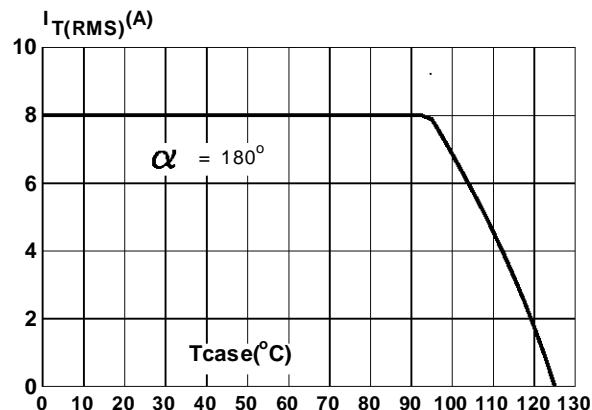


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

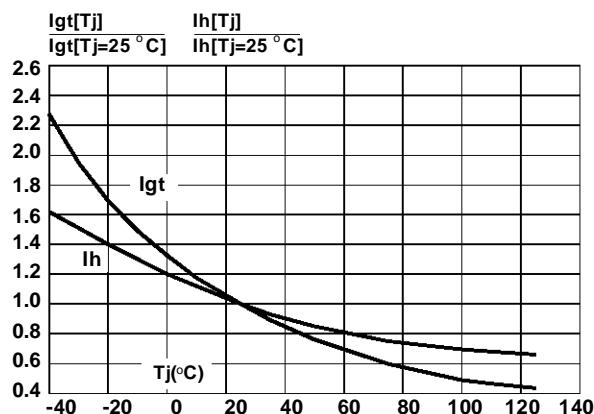


Fig.2 : Correlation between maximum power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.

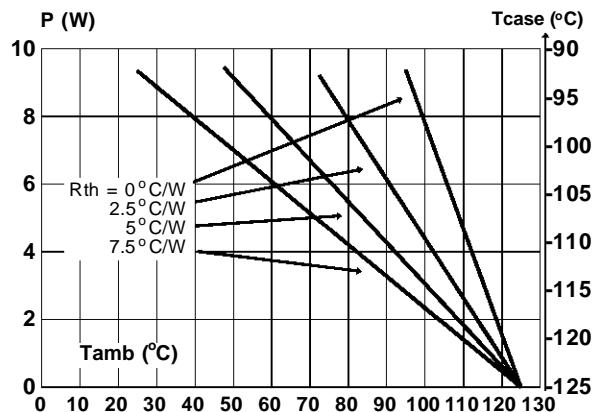


Fig.4 : Thermal transient impedance junction to case and junction to ambient versus pulse duration.

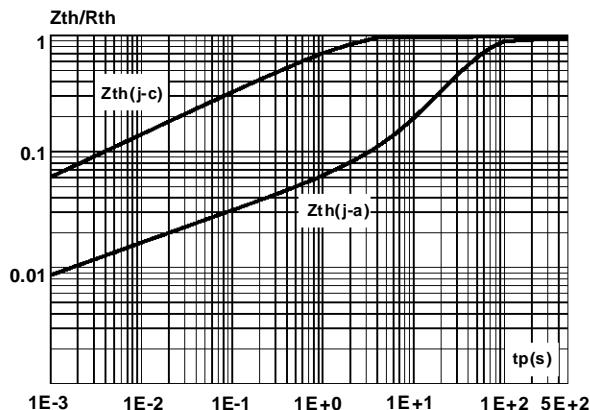
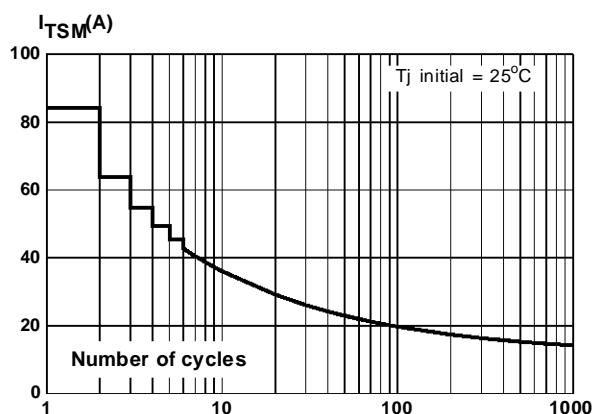


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.



T820W / 830W

Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t_p \leq 10\text{ms}$, and corresponding value of I^2t .

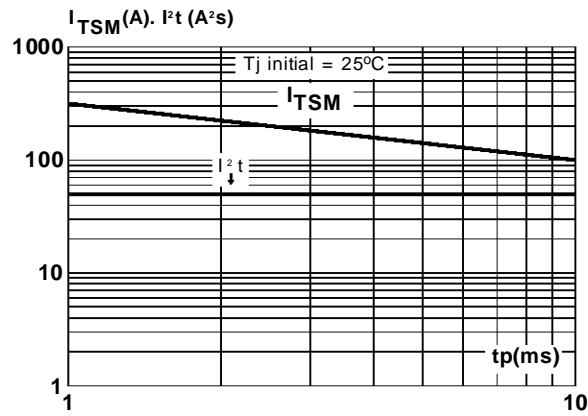
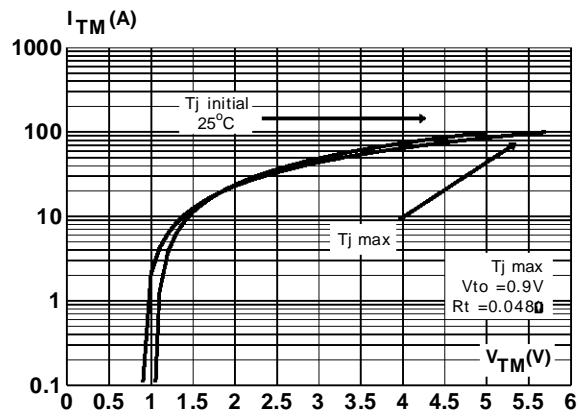


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA
ISOWATT220AB

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	10	10.4	0.393	0.409
B	15.9	16.4	0.626	0.645
B1	9.8	10.6	0.385	0.417
C	28.6	30.6	1.126	1.204
D	16 typ		0.630 typ	
E	9	9.3	0.354	0.366
H	4.4	4.6	0.173	0.181
I	3	3.2	0.118	0.126
J	2.5	2.7	0.098	0.106
L	0.4	0.7	0.015	0.027
M	2.5	2.75	0.098	0.108
N	4.95	5.2	0.195	0.204
N1	2.4	2.7	0.094	0.106
O	1.15	1.7	0.045	0.067
P	0.75	1	0.030	0.039

Cooling method : C

Marking : Type number

Weight : 2.1g

Recommended torque value : 0.55 m.N.

Maximum torque value : 0.70 m.N.

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1995 SGS-THOMSON Microelectronics - Printed in Italy - All rights reserved.

SGS-THOMSON Microelectronics GROUP OF COMPANIES

 Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -
 Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.